503060859 11/13/2014

# PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT3107461

SUBMISSION TYPE:	CORRECTIVE ASSIGNMENT
NATURE OF CONVEYANCE:	Corrective Assignment to correct the THIRD INVENTOR'S NAME FROM STEFAN JOHANNES MARTI TO STEFAN JOHANNES WALTER MARTI previously recorded on Reel 034111 Frame 0731. Assignor(s) hereby confirms the ASSIGNMENT OF ASSIGNOR'S INTEREST.

### **CONVEYING PARTY DATA**

Name	Execution Date
ERIC LIU	10/30/2014
SEUNG WOOK KIM	10/21/2014
STEFAN JOHANNES WALTER MARTI	10/21/2014

### **RECEIVING PARTY DATA**

Name:	QUALCOMM Incorporated	
Street Address:	5775 Morehouse Drive	
City:	San Diego	
State/Country:	CALIFORNIA	
Postal Code: 92121		

### **PROPERTY NUMBERS Total: 2**

Property Type	Number
Application Number:	14363783
PCT Number:	US2011063804

### **CORRESPONDENCE DATA**

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

**Phone:** 650-326-2400

**Email:** Ifitzsimmons@kilpatricktownsend.com

Correspondent Name: KILPATRICK TOWNSEND & STOCKTON LLP

Address Line 1: TWO EMBARCADERO CENTER

Address Line 2: EIGHT FLOOR

Address Line 4: SAN FRANCISCO, CALIFORNIA 94111

ATTORNEY DOCKET NUMBER:	141997 (906963)
NAME OF SUBMITTER:	URMIL DAVE
SIGNATURE:	/Urmil Dave/
DATE SIGNED:	11/13/2014

**Total Attachments: 5** 

PATENT

503060859 REEL: 034286 FRAME: 0639

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### 503049672 11/05/2014

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT3096272

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

### **CONVEYING PARTY DATA**

Name	Execution Date
ERIC LIU	10/30/2014
SEUNG WOOK KIM	10/21/2014
STEFAN JOHANNES MARTI	10/21/2014

### **RECEIVING PARTY DATA**

Name:	QUALCOMM Incorporated	
Street Address:	5775 Morehouse Drive	
City:	San Diego	
State/Country:	CALIFORNIA	
Postal Code:	92121	

### **PROPERTY NUMBERS Total: 2**

Property Type	Number
Application Number:	14363783
PCT Number:	US2011063804

### CORRESPONDENCE DATA

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

**Phone:** 650-326-2400

Email: Ifitzsimmons@kilpatricktownsend.com

Correspondent Name: KILPATRICK TOWNSEND & STOCKTON LLP

Address Line 1: TWO EMBARCADERO CENTER

Address Line 2: EIGHT FLOOR

Address Line 4: SAN FRANCISCO, CALIFORNIA 94111

ATTORNEY DOCKET NUMBER:	141997 (906963)	
NAME OF SUBMITTER:	URMIL DAVE	
SIGNATURE:	/Urmil Dave/	
DATE SIGNED:	11/05/2014	

**Total Attachments: 4** 

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#### ASSIGNMENT

WHEREAS, WE,

- 1. Eric LIU, a citizen of the United States of America, having a mailing address located at 475 Ave Del Ora, Redwood City, CA 94062 and a resident of Redwood City, CA.
- 2. Seung Wook KIM, a citizen of Korea, having a mailing address located at 20488 Stevens Creek Blvd., Apt. 1302, Cupertino, CA 95014 and a resident of Cupertino, CA.
- 3. Stefan Johannes Walter MARTI, a citizen of Switzerland, having a mailing address located at 22 Starview Drive, Oakland, CA 94618 and a resident of Oakland, CA.

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to LOW POWER INTEGRATED CIRCUIT TO ANALYZE A DIGITIZED AUDIO STREAM (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged. WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No. 14/363,783 Qualcomm Reference No. 141997, which is a 371 international of PCT/US2011/063804 filed December 7, 2011, Qualcomm Reference No. 141997WO (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the

world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at		, on			
	LOCATION	•	DATE	Eric LIU	
Done at		, on			
	LOCATION		DATE	Seung Wook KIM	
	Oak All		A. DI SOME	- M. I. K. I. I.	
Done at	YWV /4170 -	, on	004 4 1701A		
	LOCATION		DATE	Stefijn Johannes Walter MARTI	

world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

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AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at	rough, Very Son	10/30/204	
	LOCATION	DATE	Éric LIU
		•	
Done at	, on		
· <del></del>	LOCATION	DATE	Seung Wook KIM
٠.		•	
Done at	• 011		
	LOCATION	DATE	Stefan Johannes Walter MARTI

world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at	, on		
	LOCATION	DATE	Eric LIU
Done at	lupertino. 4.or	10/21/2014	
	LOCATION	DATE	Seung Wook KIM
Done at	, or	<b>\</b>	
	LOCATION	DATE	Stefan Johannes Walter MARTI

PATENT REEL: 034286 FRAME: 0645

**RECORDED: 11/13/2014**